RENESAS

HVU383B

Variable Capacitance Diode for VCO

REJ03G0082-0100Z (Previous: ADE-208-824) Rev.1.00 Sep.17.2003

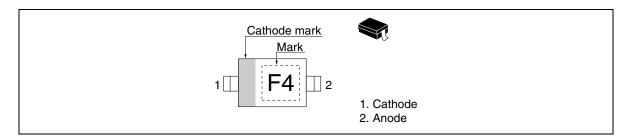
Features

- High capacitance ratio. (n = 2.0 min)
- Low series resistance. (rs = 0.5Ω max)
- Good C-V linearity.
- Ultra small Resin Package (URP) is suitable for surface mount design.

Ordering Information

Туре No.	Laser Mark	Package Code
HVU383B	F4	URP

Pin Arrangement





Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit	
Reverse voltage	V _R	15	V	
Junction temperature	Tj	125	°C	
Storage temperature	Tstg	-55 to +125	°C	

Electrical Characteristics

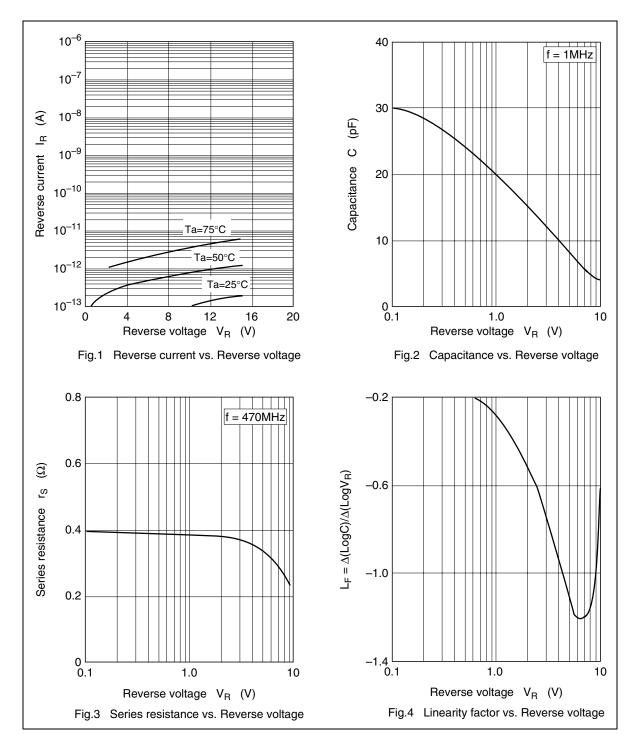
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I _{R1}	_	_	10	nA	V _R = 15 V
	I _{R2}	_	_	100		$V_{_{\rm R}}$ = 15 V, Ta = 60°C
Capacitance	C ₁	19.0	_	21.0	pF	$V_{_{\mathrm{R}}}$ = 1 V, f = 1 MHz
	C_4	8.5	_	10.0		$V_{R} = 4 V, f = 1 MHz$
	C ₇	4.5	_	5.5		$V_{_{\rm R}} = 7 \text{ V}, \text{ f} = 1 \text{ MHz}$
Capacitance ratio	n,	2.0	_	_	_	C ₁ /C ₄
	n ₂	3.5	_	_	_	C ₁ /C ₇
Series resistance	r _s	_	_	0.5	Ω	V _R = 1 V, f = 470 MHz



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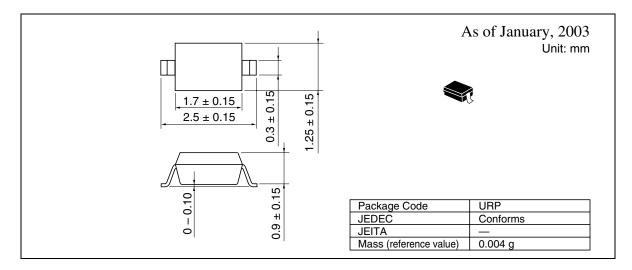
Main Characteristic



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Package Dimensions





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